



ES2A/A - ES2D/A

#### 2.0A SURFACE MOUNT SUPER-FAST RECTIFIER

#### Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time For High Efficiency
- Surge Overload Rating to 50A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony)
  (Note 2)

#### **Mechanical Data**

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 3
- Polarity: Cathode Band or Cathode Notch
- SMA Weight: 0.064 grams (approximate)
- SMB Weight: 0.093 grams (approximate)





Bottom View

#### Ordering Information (Note 3)

Part Number	Case	Packaging
ES2xA-13-F	SMA	5000/Tape & Reel
ES2x-13-F	SMB	3000/Tape & Reel

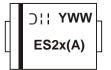
\* x = Device type, e.g. ES2BA-13-F (SMA package); ES2A-13-F (SMB package).

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.

3. For packaging details, go to our website at http://www.diodes.com.

### **Marking Information**



ES2XA = Product type marking code, ex: ES2BA (SMA package) ES2X = Product type marking code, ex: ES2A (SMB package) CH = Manufacturers' code marking YWW = Date code marking Y = Last digit of year (ex: 2 for 2002) WW = Week code (01 to 53)



#### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.						
Characteristic		ES2A/A	ES2B/A	ES2C/A	ES2D/A	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 4)	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	150	200	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	105	140	V
Average Rectified Output Current @ T <sub>T</sub> = 11	0°C lo		2	2.0		А
Non-Repetitive Peak Forward Surge Current 8.3ms Single half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>		Ę	50		А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 5)	$R_{\theta JT}$	20	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

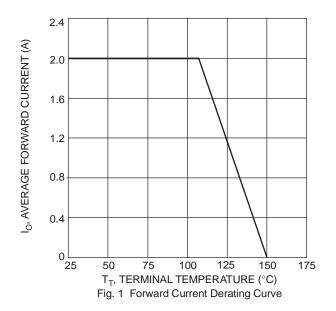
## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

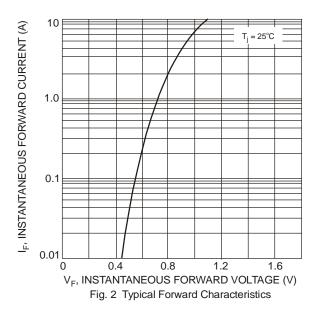
Characteristic		Symbol	Value	Unit
Forward Voltage	@ I <sub>F</sub> = 2.0A	V <sub>FM</sub>	0.92	V
Peak Reverse Current at Rated DC Blocking Voltage (Note 4)	@ T <sub>A</sub> = 25°C @ T <sub>A</sub> = 125°C		5.0 350	μΑ
Typical Total Capacitance (Note 6)		CT	25	pF
Reverse Recovery Time (Note 7)		t <sub>rr</sub>	25	ns

Notes: 4. Short duration pulse test used to minimize self-heating effect.

5. Unit mounted on PC board with 5.0 mm<sup>2</sup> (0.013 mm thick) copper pads as heat sink.

6. Measured at 1.0MHz and applied reverse voltage of 4.0V DC. 7. Measured with  $I_F = 0.5A$ ,  $I_R = 1.0A$ ,  $I_{rr} = 0.25A$ . See Figure 5.







# ES2A/A - ES2D/A

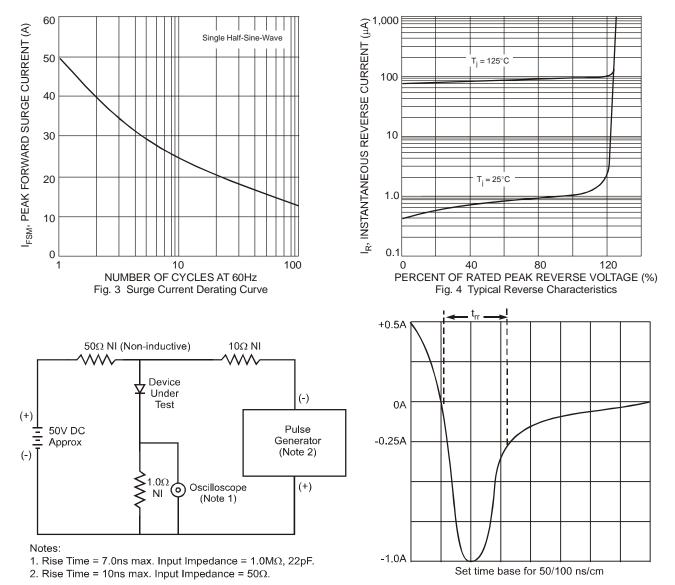
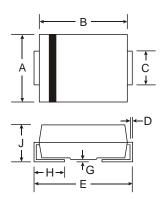


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

# **Package Outline Dimensions**

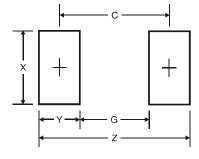


SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
С	1.27	1.63		
D	0.15	0.31		
E	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	2.01	2.30		
All Dimensions in mm				

SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
С	1.96	2.21		
D	0.15	0.31		
E	5.00	5.59		
G	0.05	0.20		
н	0.76	1.52		
J	2.00	2.50		
All Dimensions in mm				



### Suggested Pad Layout



SMA Dimensions	Value (in mm)
Z	6.5
G	1.5
Х	1.7
Y	2.5
С	4.0

SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
Х	2.3
Y	2.5
С	4.3

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